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Characterization study of bonded and unbonded polydimethylsiloxane aimed for bio-micro-electromechanical systems-related applications

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Abstract. Authors have demonstrated that by controlling the mixing ratio of polydimethylsiloxane's (PDMS's) two components—base polymer (part A) and a curing agent (part B)—different mechanical properties of PDMS can be achieved. Test results show that the Young's modulus decreases as the increasing of mixing ratios (A:B). However, there is a transitional mixing ratio (part A:part B=10) after which the Young's modulus is almost independent of the mixing ratio. The PDMS's thickness plays an important role in determining the mechanical properties. The results show that the thinner the PDMS, the stiffer it behaves. The bonding strength between two cured PDMS parts with different mixing ratios shows that it depends on the mixing ratio. A maximum bonding strength of 130 kPa occurs on a bonded couple with mixing ratios of 30A:1B and 3A:1B, respectively. The fracture on bonded specimens does not occur at the bonding interfaces. Instead it occurs at the side with a larger portion of part A. The intermediate material property formed at the interface is attributed to the diffusion layer formed. © 2007 Society of Photo-Optical Instrumentation Engineers. [DOI: 10.1117/1.2731381]

Subject terms: PDMS; mechanical properties; mixing ratios; bonding strength.

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1 Introduction

Polydimethylsiloxane (PDMS) elastomer, due to its unique properties, has been widely used in fabricating lab-on-a-chip (LOC) or micro total analysis systems (μ TAS) for biological applications. PDMS is biocompatible, which is critical for biological assays. PDMS is optically transparent to wavelengths down to near 256 nm.¹ The transparent nature of PDMS is suitable for biological analysis using widely adopted methods such as fluorescence. PDMS's elastic and soft nature make it ideal for the reversible deformations needed during analytical operations. μ TAS or LOC systems made of PDMS can be realized by molding casting or soft lithography with high fidelity.^{2–5} PDMS can seal to itself and other flat surfaces with a good watertight capability. Meanwhile, the fabrication of LOC or μ TAS or other microdevices using PDMS are cost-effective, which makes PDMS suitable for disposable uses in biomedical applications.⁶ As a result, PDMS is getting more and more interest as a bio-micro-electromechanical systems (bio-MEMS) material, and the application of utilizing PDMS are increased greatly in a broad range of applications. For example, Young Shik Shin et al.⁷ succeed in fabricating a PDMS-based micro polymer chain reaction (PCR) chip using a replica modeling method. Ceriotti⁸ reported a μ TAS system, a capillary electrochromatography microchip fabricated with PDMS consisting of a 10- μ m particle-free slanted “double-T” injector. PDMS has also been used to

fabricate a microarray for DNA analysis. Xiaomei et al.⁹ introduced a disposable three-dimensional (3D) microchip array for DNA amplification made of PDMS in which 1064 column chambers were fabricated.

PDMS normally contains a base polymer (part A) and a curing agent (part B). PDMS is cured by an organometallic cross-linking reaction promoted by heating, when the two parts are mixed with a certain mixing (weight) ratio.¹⁰ Very importantly, cured PDMS can be bonded together with a plasma treatment or by controlling the mixing ratios between the bonding couple.¹¹ The capability to bond makes PDMS prevail in fabricating stacked 3D MEMS devices.

Many of PDMS-based microbiological devices require

Fig. 1 MTS Tytron 250 microforce tester system (with PDMS samples mounted on two leveled clamps) and control software interface.

Table 1 Cured RTV 615 properties.

Properties	Unit	Value
Hardness, shore A durometer		44
Elongation	%	120
Shrinkage	%	0.2
Refractive index		1.406
Dielectric strength	KV/mm (V/mil)	19.7(500)
Dielectric constant at 1000 Hz		2.7
Dissipation factor at 1000 Hz		0.0006
Volume resistivity	Ohm-cm	1.8×10^{15}
Thermal conductivity	deg C/cm	0.00045
Coefficient of expansion	cm/cm, deg C	27×10^{-5}
Specific heat	cal/gm, deg C	0.3

manipulating a PDMS membrane to realize the microfluidic management, which is the key function for biological reactions. The actuation mechanisms on PDMS include, but are not limited to, (1) pneumatic,¹¹ (2) thermomechanical,¹² and (3) hydraulic.¹³ To accommodate these actuations, PDMS's mechanical properties are critical to fulfill microdevices' needs. For example, the actuation force required to manipulate a PDMS membrane is proportional to PDMS's thickness and stiffness. In addition, 3D structures are realized by bonding, and the bonding strength between the bonded couple is a key factor in determining the workability as well as the reliability of the devices fabricated. Therefore, the mechanical properties of PDMS are very important, but not enough adequate data are available.

In this paper, both bonded and unbonded PDMS's mechanical properties are investigated considering the influence of varied composition, membrane thickness, and bonding conditions. PDMS preparation, the test methods, and results are presented and discussed.

2 Experimental Preparation

2.1 PDMS

Silicone RTV 615 (General Electric) was studied in this paper. Part A of RTV 615 is a siloxane oligomer containing polydimethylsiloxane bearing vinyl groups and a platinum catalyst. Part B of RTV 615, the cross-linking oligomers, contains a cross-linker containing silicon hydride (Si-H) groups, which form covalent bonds with vinyl groups¹⁰ when mixed with part A. The PDMS curing is enhanced by an additional heating process after the mixing of parts A and B. A typical mixing ratio is around 10A:1B in weight. Table 1 provides manufacturer's cured PDMS properties at this mixing ratio. However, mechanical properties with different mixing ratios, especially for those with large mixing ratios, which are of interest to the research community are not available.

Table 2 Specimen series of bonded couples.

Series Number	1	2	3	4
Ratio 1 (A:B)	20:1	30:1	40:1	50:1
Ratio 2 (A:B)	2:1	3:1	4:1	5:1

2.2 Bonding Methods

Bonding has been the main approach in fabricating 3D biological assays. One way of bonding PDMS has been realized with oxygen plasma treatment, during which oxygen plasma leads to oxidation on surface, and chain scission as well as cross-linking are ensured by the formation of a silicalike surfaces.¹⁴ Another bonding method was developed by controlling mixing ratios between the bonded couple.¹¹ The second method was used in this research due to its ease of application and cost-effectiveness. By doing this, various mixing couples were prepared and brought together for bonding. The couples are prepared by a molding method. With a different mixing ratio, uncured PDMS was poured into a leveled 1-in.² plastic holder and cured at 65-deg C. When cured, two PDMS parts with different mixing ratios are put together under pressure to make full contact. The bonding was realized after heating the contacted couples at 80-deg C for 1.5 h under a weight of 125 g.¹¹

2.3 Mixing and Curing Process

PDMS specimens were prepared with seven different mixing ratios: 1:2, 1:5, 1:7.5, 1:10, 1:12.5, 1:20, and 1:50 (ratio of B:A). Parts A and B were mixed with these ratios and the mixture was cast into a 1-in.² mold. The PDMS was cured under heat at 65-deg C after degassing. The heating process was performed on a leveled stage to make sure the cured PDMSs are uniform in thickness. Then cured PDMS was cut into samples with a size of $2 \times 10 \times 1$ mm after peeling it off the mold. Using the same seven different mixing ratios, another set of samples were prepared for mechanical testing with a geometric effect. For each test, two samples with the same mixing ratio but different thicknesses were used. The thick sample is made by casting PDMS into a 1-in.² mold and peeling it off when it is fully cured. The thinner PDMS membrane sample was prepared using a spin-coating method. By manipulating the spin speed, the PDMS's thickness can be as thin as 20 to 30 μ m. Cutting the two samples into the same size, 2×10 mm, is manually performed with care. Then, four couples formed with different mixing ratios (Table 2) were prepared for the bonding strength test.

2.4 Test Frame and Test Procedure

The mechanical properties were characterized using a MTS Tytron 250 microforce tester system, as shown in Fig. 1. The tester has a resolution in force of 10 μ N and an accuracy of 0.1 μ m in displacement measurement. The test specimen was mounted onto a double clamped gripper and held firmly as shown in Fig. 1. After the installation, a tensile force was applied to the specimen. The elongation and the corresponding force during the test were recorded

Fig. 2 Test procedure. Mounted sample is pulled under the force from MTS system until it is broken. All the force and displacement data will be recorded by the computer and saved as an Excel file for future analysis.

automatically by MTS's BASIC TESTWARE. Figure 2 demonstrates the test procedure. All samples prepared as discussed above were mounted on the MTS system and tested.

3 Results and Discussion

3.1 Mechanical Properties of PDMS with Different Mixing Ratios

After recording the force and the elongation of each tested specimen, the stress and the corresponded strain can be

derived. A stress-strain relationship of a PDMS specimen fabricated is presented in Fig. 3. At the beginning of the test, the resulting strain and stress have a linear relationship, which shows an elastic nature of the PDMS, a silicone rubber material. The Young's modulus was derived from the slope of the stress-strain curve. However, PDMSs with different weight mixing ratios behaved quite differently. Figure 4 and Table 3 show the change of Young's modulus versus the weight mixing ratios tested. It can be clearly

Fig. 3 Stress-strain relationship of PDMS with mixing ratio 10A:1B.

Fig. 4 Young's modulus versus weight mixing ratio.

seen from this curve that the Young's modulus decreases as the ratio of $A:B$ increases. This means the higher the portion of part A in the PDMS, the lower the resulting Young's modulus (the softer the nature). This should be considered as the contribution of the polymerization of the materials: the larger the ratio, the more unreacted base polymer presented and the softer the final stage materials. Interestingly, the Young's modulus drops dramatically when the part A ratio is relatively small ($A:B < 10$). For example, it decreases from 2.1 to 0.6 MPa when the mixing ratio is increased from 2 to 10. However, when the weight mixing ratio is greater than 10, the resulting Young's modulus of PDMS is almost independent of the mixing ratios (Fig. 4). When the mixing ratio increased from 10 to 50, the change in Young's modulus was approximately 0.5 MPa only.

Table 3 Derived Young's modulus versus mixing ratios.

Weight Mixing Ratio (B:A)	Young's Modulus (KPa)
2.00	2133
5.00	1565
7.50	1396
12.50	405.4
10.00	610.8
20.00	238.2
50.00	99.35

3.2 Mechanical Properties with Different Thicknesses

Scaling law happens on stiffer materials such as silicon in the MEMS community, as well as nickel and nickel alloys. A question may be asked if PDMS has a similar issue. To answer this question, a mechanical test was conducted to find the relationship between mechanical properties and the PDMS's thickness. The derived Young's modulus versus PDMS's (12.5A:1B) thickness is presented in Fig. 5. As shown in Fig. 5, the Young's modulus of PDMS with a thickness of 100 μm is more than twofold greater than that of a PDMS with a thickness of 1.8 mm.

3.3 Bonding Strength of PDMS

As shown in Table 2, four pairs of bonded PDMS were selected for the bonding test. All specimens were prepared under the same conditions (heated at 80-deg C for 1.5 h right after the curing process for individual part). After bonding, specimens were cut from these bonded PDMS couples in a way that the bonded interface was in the middle vertical to the loading direction, as shown in Fig. 6, and the specimens' sizes are both $2 \times 10 \times 3$ mm, which results in the bonding surface of the two coupled PDMS being right at the middle, which helps to eliminate the error caused by sloped mounting. Due to the difference of concentration at two sides of the bonding pieces, a diffusion layer is formed at the contact surface, as magnified in Fig. 6. It is indicated that the larger portion of part A, the thicker the bonding diffusion layer that is formed. The cut specimens were mounted to the MTS test system in a way that the bonded interface was perpendicular to the loading direction. A tensile force was then applied to the specimen continuously until the specimen was broken. The bonding

Fig. 5 Young's modulus versus PDMS thickness.

strength versus mixing ratios is shown in Fig. 7. It is indicated that the bonding strength strongly depends on the mixing ratio. The bonding strength increases first as the mixing ratio is increased. However, a maximum bonding strength of 130 kPa occurred on the bonded couple between mixing ratios 30A:1B and 3A:1B. After this transition point, the resulting bonding strength decreases as the ratio of part A relative to part B increases (Fig. 7). After examining the broken specimens, it was found that the fracture surface did not occur at the bonded interface. Instead, it occurred at the side with the larger portion of part A and close to the bonded interface. This can be explained by the fact that the diffusion layer formed at the bonded interface. From Fig. 5 we know that the larger portion of part A will result in a soft natured PDMS. The diffusion layer has higher concentration of agent part B, and thus a relatively smaller portion of part A, in comparison to the broken part. Therefore, the resulting PDMS of this thin layer is rela-

tively stiffer. The diffusion layer has a lower concentration of agent part B in comparison to the unbroken part. Therefore, the bonded interface has an intermediate mechanical stiffness due to the diffusion.

4 Conclusion

We have demonstrated that by controlling the mixing ratio of PDMS's two components (part A and part B), different mechanical properties of PDMS can be achieved. Young's modulus decreases as the mixing ratios increase. There is a transitional mixing ratio (part A:part B=10) after which the Young's modulus is almost independent of the mixing ratio tested. PDMS's thickness plays an important role in determining mechanical properties. The thinner the PDMS, the stiffer it behaves along its normal direction. The bonding strength between PDMS couples with different mixing ratios shows that it depends on the mixing ratio. A maximum

Fig. 6 Cross-sectional view of bonded PDMS couples with different mixing ratios and diffusion layer between bonding parts.

Fig. 7 Bonding strength versus mixing ratios of bonded couples.

bonding strength of 130 kPa occurred on a bonded couple between mixing ratios of 30A:1B and 3A:1B. The fracture of bonded PDMS does not occur at the bonding interface; it occurs at the side with large portion of part A. This implies that the interface is not the weakest location, due to the fact that intermediate material property is formed by the diffusion between the bonded couple. This featured property is good and important for device design, because it provides the opportunity to tailor it in designing devices by controlling the concentration of PDMS, and the bonded interface is free of concern in terms of reliability or deformation. On the other hand, for actuation purposes, one has to pay attention to the properties at the interface. The good news is that the bonded interface forms a graded material that links two parts together continuously with intermediate mechanical properties. For multilayer structures, this feature is also important because it is possible to reinforce the structure's property by alternating the arrangement of bonded layers. These results will be very helpful to assist the design and fabrication of various MEMS devices using PDMS for biological applications.

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